ne<mark>x</mark>peria

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

16-bit transceiver with direction pin; 3.6 V tolerant; 3-stateRev. 3 — 31 January 2013Product data s

Product data sheet

1. **General description**

The 74AVC16245 is a 16-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable inputs (nOE) for easy cascading and two send/receive inputs (nDIR) for direction control. Inputs nOE control the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74AVC16245 is designed to have an extremely fast propagation delay and a minimum amount of power consumption.

To ensure the high-impedance output state during power-up or power-down, tie pins nOE to V_{CC} through a pull-up resistor (Live Insertion).

A Dynamic Controlled Output (DCO) circuitry is implemented to support termination line drive during transient (see Figure 4 and Figure 5)

Features and benefits 2.

- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-1A (2.7 V to 3.6 V)
- CMOS low power consumption
- Input/output tolerant up to 3.6 V
- Dynamic Controlled Output (DCO) circuit dynamically changes output impedance, resulting in noise reduction without speed degradation
- Low inductance multiple VCC and GND pins to minimize noise and ground bounce
- Supports Live Insertion

Ordering information 3.

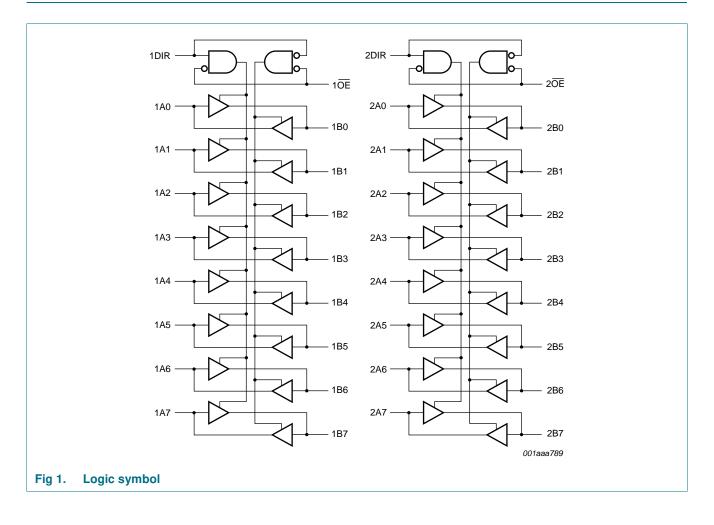
Table 1. **Ordering information**

Type number	Package	Package				
	Temperature range	Name	Description	Version		
74AVC16245DGG	-40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1		



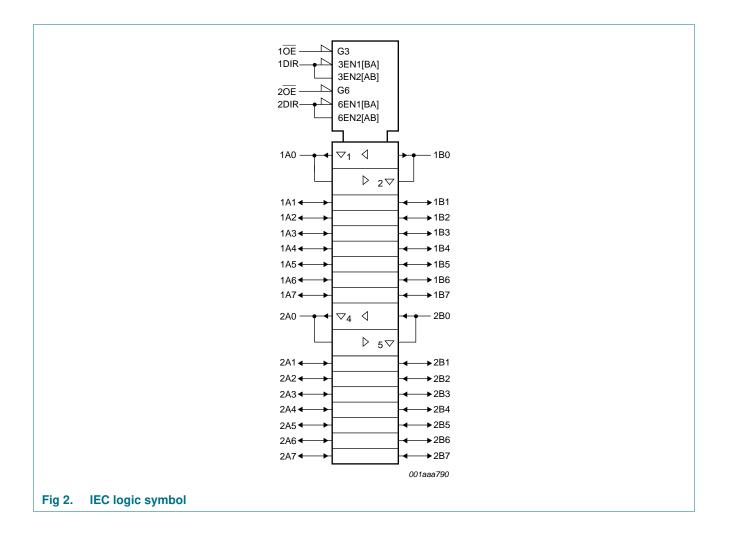
16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

Functional diagram 4.



74AVC16245

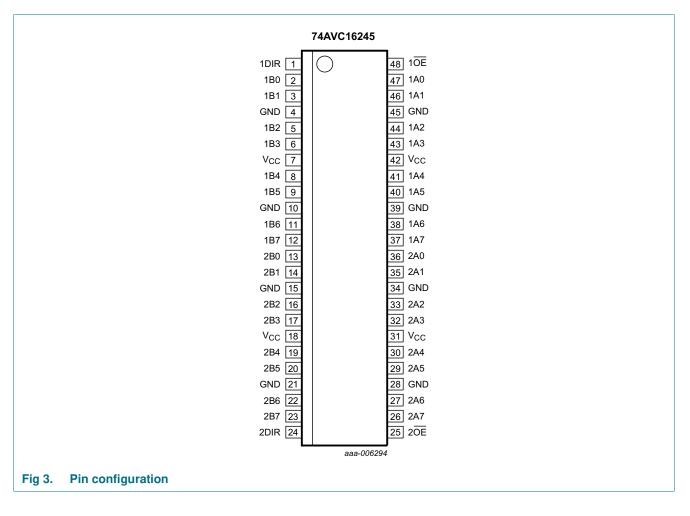
16-bit transceiver with direction pin; 3.6 V tolerant; 3-state



16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

5. Pinning information

5.1 Pinning



16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

5.2 Pin description

Table 2. Pin	description	
Symbol	Pin	Description
1DIR, 2DIR	1, 24	direction control input
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	data input/output
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	data input/output
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1 <u>0E</u> , 2 <u>0E</u>	48, 25	output enable input (active LOW)
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	data input/output
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	data input/output

6. Functional description

Table 3.	Function table ^[1]				
nOE nDIR		Outputs	Outputs		
nOE		nDIR	nAn	nBn	
L		L	A = B	inputs	
L		Н	inputs	B = A	
Н		Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	output HIGH or LOW	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = −40 °C to +125 °C	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 60 °C, the value of P_{tot} derates linearly with 5.5 mW/K.

74AVC16245 Product data sheet

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

8. Recommended operating conditions

Table 5.	Recommended operating	conditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	according to JEDEC Low Voltage Standards	1.4	-	1.6	V
			1.65	-	1.95	V
			2.3	-	2.7	V
			3.0	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	3.6	V
Vo	output voltage	output HIGH or LOW	0	-	V_{CC}	V
		output 3-state	0	-	3.6	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t / \Delta V$	input transition rise and fall	V _{CC} = 1.4 V to 1.6 V	0	-	40	ns/V
	rate	V _{CC} = 1.65 V to 1.95 V	0	-	30	ns/V
		$V_{CC} = 2.3 \text{ V} \text{ to } 3.0 \text{ V}$	0	-	20	ns/V
		V _{CC} = 3.0 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -	40 °C to +85 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	V _{CC}	-	-	V
		$V_{CC} = 1.4 V$ to 1.6 V	$0.65 \times V_{CC}$	0.9	-	V
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V	$0.65 \times V_{CC}$	0.9	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	1.2	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	1.5	-	V
V _{IL} LOW-level input voltage	LOW-level input voltage	V _{CC} = 1.2 V	-	-	GND	V
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V	-	0.9	$0.35 \times V_{CC}$	V
		V _{CC} = 1.65 V to 1.95 V	-	0.9	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	1.2	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	1.5	0.8	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = –100 $\mu A;$ V_{CC} = 1.65 V to 3.6 V	$V_{CC}-0.20$	V _{CC}	-	V
		$I_{O} = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	$V_{CC}-0.35$	$V_{CC}-0.21$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	$V_{CC}-0.45$	$V_{CC}-0.25$	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.55$	$V_{CC}-0.37$	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.70$	$V_{CC}-0.47$	-	V

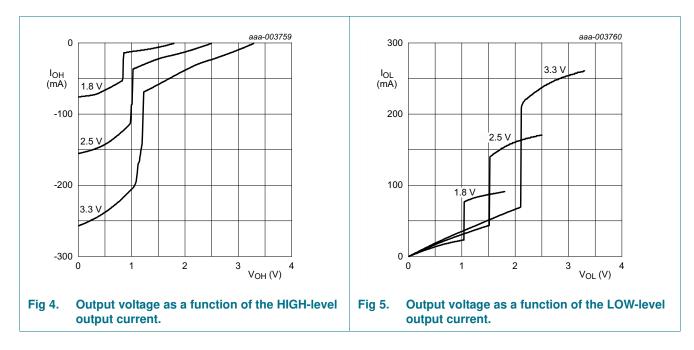
6 of 15

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

At recom	mended operating conditions	. Voltages are referenced to GND (ground	= 0 V).			
Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		I_O = 100 $\mu A;V_{CC}$ = 1.65 V to 3.6 V	-	GND	0.20	V
		$I_{O} = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	0.22	0.35	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.24	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.38	0.55	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.53	0.70	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 1.4$ V to 3.6 V	-	0.1	2.5	μ A
I _{OFF}	power-off leakage current	$V_{I} \text{ or } V_{O} = 3.6 \text{ V}; V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_O = V_{CC} \text{ or } GND$				
		$V_{CC} = 1.4 \text{ V} \text{ to } 2.7 \text{ V}$	-	0.1	5	μ A
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.1	10	μ A
I _{CC}	supply current	$V_I = V_{CC} \text{ or } GND; I_O = 0 \text{ A}$				
		V_{CC} = 1.4 V to 2.7 V	-	0.1	20	μA
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.2	40	μA
CI	input capacitance		-	5.0	-	pF

Table 6. Static characteristics ... continued

[1] All typical values are measured at $T_{amb} = 25$ °C.



9.1 Graphs

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40) °C to +85	S°C	Unit
				Min	Typ ^[2]	Max	
t _{pd}	propagation delay	nAn to nBn; nBn to nAn; see Figure 6	[1]				
		$V_{CC} = 1.2 V$		-	2.8	-	ns
		$V_{CC} = 1.4 V$ to 1.6 V		-	1.8	-	ns
		V _{CC} = 1.65 V to 1.95 V		0.7	1.8	3.0	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		0.6	1.3	1.9	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.5	1.1	1.7	ns
t _{en}	enable time	nOE to nAn, nBn; see Figure 7	[1]				
		$V_{CC} = 1.2 V$		-	5.9	-	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	3.9	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.4	3.3	6.5	ns
		$V_{CC} = 2.3 \text{ V}$ to 2.7 V		1.0	2.4	4.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.7	2.0	3.7	ns
t _{dis}	disable time	nOE to nAn, nBn; see Figure 7	[1]				
		V _{CC} = 1.2 V		-	6.9	-	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	4.8	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.2	3.7	6.0	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.1	2.0	4.2	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.2	2.2	3.7	ns
C _{PD}	power dissipation	per input; $V_I = GND$ to V_{CC}	[3]				
	capacitance	outputs enabled		-	42	-	pF
		outputs disabled		-	2	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

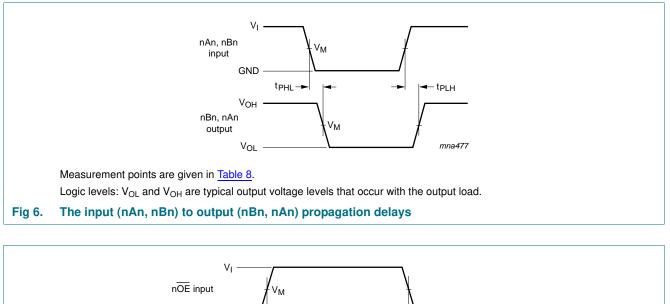
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

11. Waveforms



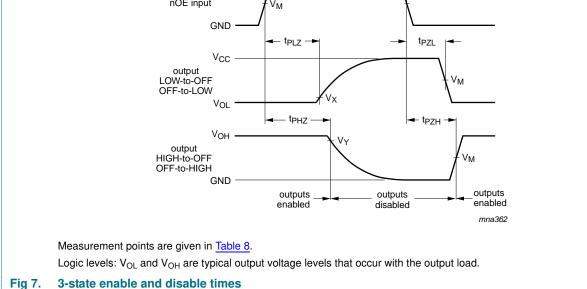


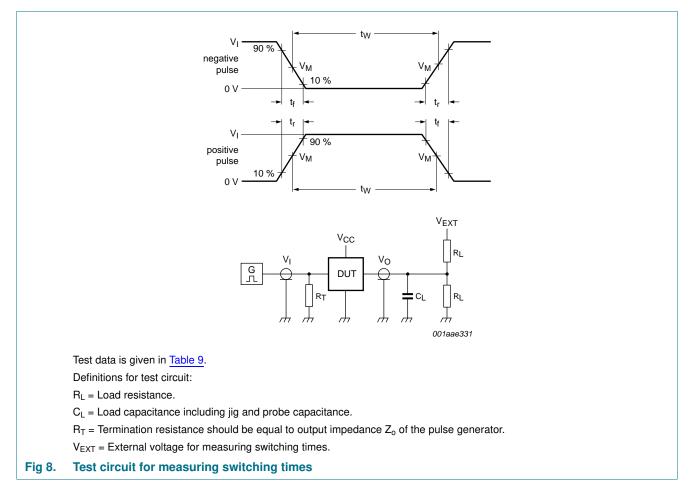
Table 8.Measurement points

Supply voltage	V _M	Input	nput				
V _{CC}		VI	$t_r = t_f$	V _X	V _Y		
1.2 V	$0.5\times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
1.4 V to 1.6 V	$0.5\times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
1.65 V to 1.95 V	$0.5\times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
2.3 V to 2.7 V	$0.5\times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
3.0 V to 3.6 V	$0.5\times V_{CC}$	V _{CC}	\leq 2 ns	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$		

74AVC16245

74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state



Supply voltage	Input		Load	Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	15 pF	2 kΩ	open	$2\times V_{CC}$	GND	
1.4 V to 1.6 V	V _{CC}	\leq 2 ns	15 pF	2 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	

74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

12. Package outline

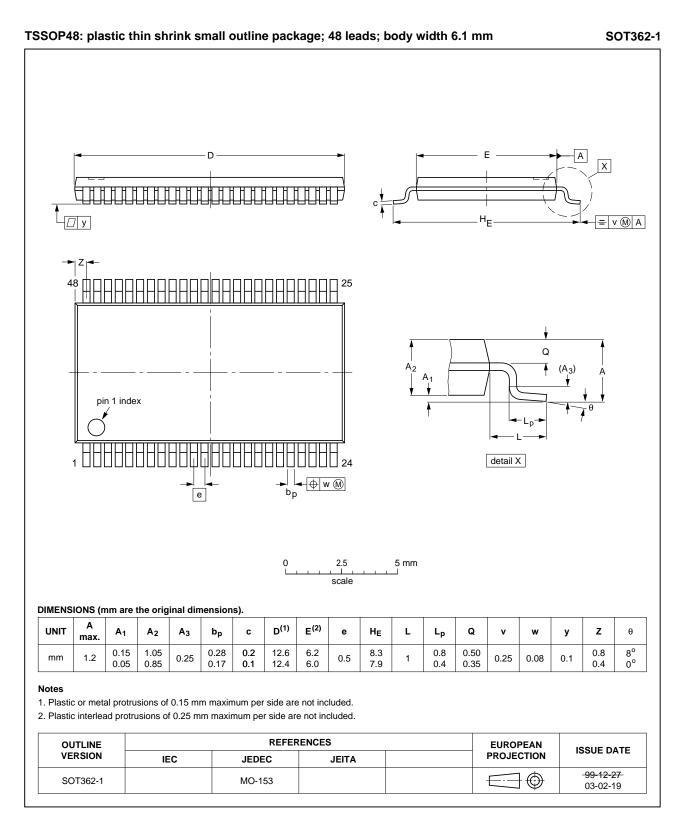


Fig 9. Package outline SOT362-1 (TSSOP48)

All information provided in this document is subject to legal disclaimers.

74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

13. Abbreviations

Table 10. A	Abbreviations
Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
TTL	Transistor-Transistor Logic

14. Revision history

Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes
74AVC16245 v.3	20130131	Product data sheet	-	-	74AVC16245 v.2
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 				
	 Legal text 	s have been adapted to tr	ne new company r	ame where appr	opriate.
74AVC16245 v.2	19991115	Product specification	-	-	74AVC16245 v.1
74AVC16245 v.1	19981211	Product specification	-	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP B.V. 2013. All rights reserved.

74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning 4
5.2	Pin description 5
6	Functional description 5
7	Limiting values 5
8	Recommended operating conditions 6
9	Static characteristics 6
9.1	Graphs
10	Dynamic characteristics 8
11	Waveforms 9
12	Package outline 11
13	Abbreviations 12
14	Revision history 12
15	Legal information 13
15.1	Data sheet status 13
15.2	Definitions 13
15.3	Disclaimers
15.4	Trademarks 14
16	Contact information 14
17	Contents 15

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2013.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 31 January 2013 Document identifier: 74AVC16245